AMDAP™ Series - Metal Powders for 3D Printing -

High thermal conductivity Metal Powder AMDAP[™] HTC45 for Directed Energy Deposition

The SKD61-based powder adjusted to a composition suitable for additive manufacturing of die-casting molds.

Hardness suitable for die-casting molds can be obtained by just directed energy deposition.

Feature

- AMDAP™ HTC45 has spherical shape, low oxygen content and high flowability produced by gas atomization.
- · AMDAP™ HTC45 is cobalt free material, the same as SKD61.
- The hardness suitable for die-casting molds of 45-50HRC can be obtained by directed energy deposition, and no post-heat treatment is required.
- The high thermal conductivity of the overlay portion enhances the cooling effect of the mold. In addition, thermal stress can be reduced and heat checking can be effectively suppressed.

Typical Chemical composition, hardness and application

AMDAP™ Series	Equivalent steel grad	Hardness range after laser metal deposition (HRC)	Typical chemical composition (mass%)					Annillandina
			С	Si	Cr	Мо	V	Application
AMDAP™ HTC45	SKD61 type Die Steel	45~50	0.23	0.1	5	1.2	0.4	Repair of die casting molds

Particle size: -150/+53µm

AMDAP HTC are a trademarks or a resgistered trademarks of Daido Steel Co., Ltd.

Characteristics

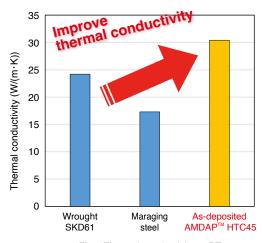


Fig.1 Thermal conductivity at RT

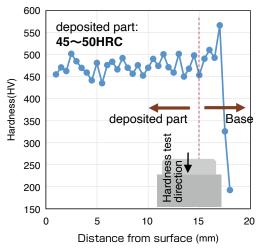
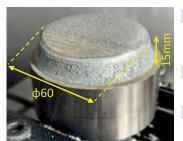


Fig.3 Hardness distribution of deposited sample



Printer

DMG MORI CO.,LTD

LASERTEC 65 DED hybrid

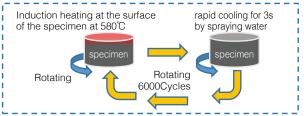
Base

Annealed SKD61

Welded part

AMDAP™ HTC45

Fig.2 Overview of deposited sample (3D-printed by FUJI co.,LTD)



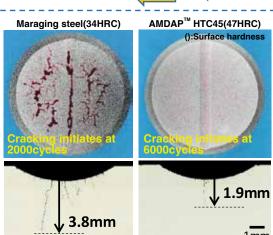


Fig.4 Heat check test results of deposited specimens (After 6000cycles, notch shape:R=6mm, depth:1mm)



Tokyo Head Office

Daido Shinagawa Building, 6-35, Konan 1-chome, Minato-ku, Tokyo, 108-8478 TEL +81-3-5495-1284

(Metal Powder Marketing & Sales Sect. Metal Powder Dept.)

Nagoya Office

10, Ryugu-cho, Minato-ku, Nagoya, Aichi, 455-0022 TEL +81-52-694-0776

Web site: https://www.daido.co.jp/en/products/powder/dap_am2/index.html

Email address: funmatsu@ask.daido.co.jp

AMDAP and HTC are trademarks or registered trademarks of Daido Steel Co.,Ltd.

■Disclaimer and copyright

The figures in this document are typical values based on the results of our tests and there is no guarantee that the figures presented will be achieved when the products are used. The information in this document is subject to change without notice. Please contact us for the latest information. Any unauthorized distribution or reproduction of the content of this document is prohibited.